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Data Sheet
Rev 01.1220

10GBASE-SW/SR 10G Ethernet 850nm MMF Mini SFF Optical Transceiver

CM85-10GM-3S-TI

Description

The CM85-10GM-3S-TI transceivers provide products for maximum bandwidth of 10Gbps and transmission up to 400m. The transceiver is provided in mini SFF with duplex LC connector interface.

Features

- Single power supply 3.3V
- Duplex LC optical connection
- Class 1 laser product compliant with EN 60825-1
- Input/Output: AC/AC
- Industrial temperature range -40°C to 85°C
- Transmit distance: 33m (OM1 Fiber), 82m (OM2 Fiber), 300m (OM3 Fiber), 400m (OM4 Fiber)

Applications

- Multimode core fiber backbone links up to 400m
- 10GBASE-SW/SR Ethernet

Diagnostics

Parameter	Range	Accuracy	Unit	Calibration
Internal Transceiver Temperature	-40 to 95	±3	°C	Internal
Internal Transceiver Voltage	3.0 to 3.6	±0.1	V	
Bias Current	0 to 15	±10%	mA	
TX Power	-8 to 0	±3	dB	
RX Average Power	-14 to 0	±3	dB	

Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit	Notes
Storage Temperature	T_S	-40	85	°C	
Supply Voltage	V_{CC}	-0.5	4.0	V	
Input Voltage	V_{IN}	-0.5	V_{CC}	V	

Recommended Operating Conditions

Parameter	Symbol	Min	Max	Unit	Notes
Case Operating Temperature	T_C	-40	85	°C	
Supply Voltage	V_{CC}	3.14	3.46	V	
Supply Current	$I_{TX} + I_{RX}$		300	mA	
Power Consumption	P	-	1.0	W	

Transmitter Electro-Optical Characteristics (V_{CC} = 3.14V to 3.46V, T_C = -40°C to 85°C)

Parameter	Symbol	Min	Typ	Max	Unit	Notes
Data Rate	B		10.3125		Gbps	
Output Optical Power (50/125um fiber, NA=0.20) (62.5/125um fiber, NA=0.275)	P_{out}	-7.1	-	-1	dBm	
Optical Modulation Amplitude	OMA	-4.3			dBm	
Extinction Ratio	ER	3.5			dB	
Center Wavelength	λ_C	840	850	860	nm	
Spectral Width (RMS)	$\Delta\lambda$	-	-	0.45	nm	
Transmitter and Dispersion Penalty	TDP			3.9	dB	
Relative Intensity Noise	RIN	-	-	-128	dB/Hz	
Output Eye	Compliant with IEEE802.3ae					
Max. P_{out} TX-DISABLE Asserted	P_{OFF}	-	-	-35	dBm	
Differential Input Impedance	Z_d	80	100	120	Ω	
Differential Input Voltage Swing	V_{DIFF}	200		800	mV	
TX_DISABLE Assert Time	t_off	-	-	100	µs	
TX_DISABLE Negate Time	t_on	-	-	2	ms	
Time to Initialize	t_init	-	-	300	ms	
TX_DISABLE Time to start reset	t_reset	10	-	-	µs	

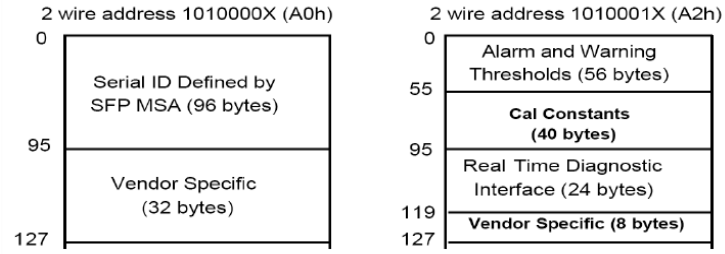
Receiver Electro-Optical Characteristics (V_{CC} = 3.14V to 3.46V, T_C = -40°C to 85°C)

Parameter	Symbol	Min	Typ	Max	Unit	Notes
Data Rate	B		10.3125		Gbps	
Optical Input Power-Maximum	P_{IN}	-1	-	-	dBm	BER<10^{-12}
Receiver Sensitivity (OMA)	P_{IN}	-	-	-11.1	dBm	BER<10^{-12}
Operating Center Wavelength	λ_C	840	-	860	nm	
Optical Return Loss	ORL	12	-	-	dB	
Loss of Signal-Asserted	P_A	-30	-	-	dBm	Note 1
Loss of Signal-Deasserted	P_D	-	-	-12	dBm	Note 1
Differential Output Impedance	Z_d	80	100	120	Ω	
Differential Output Voltage	V_{DIFF}	300	-	800	mV	

Note:

1. The LOS state is monitored and defined at SFF-8472 byte 110 bit 1.

Digital Diagnostic Memory Map



EEPROM Serial ID Memory Contents (A0h)

Address	Hex	Fields	Result
0	02(H)	identifier	Module soldered to motherboard
1	04(H)	Ext.Identifier	GBIC/SFP function is defined by two-wire interface ID only
2	07(H)	Connector	LC
3	10(H)	Transceiver	10G Base-SR;
4	00(H)	Transceiver	Unallocated
5	00(H)		
6	00(H)		
7	00(H)		
8	00(H)		
9	0C(H)	Transceiver	Multimode;50um(M5;M5E);Multimode;62.5um(M6);
10	80(H)	Transceiver	1200MBytes/sec;
11	06(H)	Encoding	64B/66B
12	67(H)	BR(Nominal)	10300Mbps
13	00(H)	Rate Identifier	Unspecified
14	00(H)	Length(SMFm)-km	N/A
15	00(H)	Length(SMF)	N/A
16	08(H)	Length(50μm)	8(units of 10m)
17	03(H)	Length(62.5μm)	3(units of 10m)
18	00(H)	Length(cable)	N/A
19	1E(H)	Length(OM3)	30(units of 10m)
20	41(H)	Vendor name	A
21	50(H)	Vendor name	P
22	41(H)	Vendor name	A
23	43(H)	Vendor name	C
24	20(H)	Vendor name	
25	4F(H)	Vendor name	O
26	70(H)	Vendor name	p

27	74(H)	Vendor name	t
28	6F(H)	Vendor name	o
29	20(H)	Vendor name	
30	20(H)	Vendor name	
31	20(H)	Vendor name	
32	20(H)	Vendor name	
33	20(H)	Vendor name	
34	20(H)	Vendor name	
35	20(H)	Vendor name	
36	00(H)	Transceiver	Unallocated
37	00(H)	Vendor OUI	0
38	0F(H)	Vendor OUI	0F
39	99(H)	Vendor OUI	99
40	4C(H)	Vendor PN	L
41	4D(H)	Vendor PN	M
42	32(H)	Vendor PN	2
43	34(H)	Vendor PN	4
44	2D(H)	Vendor PN	-
45	48(H)	Vendor PN	H
46	33(H)	Vendor PN	3
47	53(H)	Vendor PN	S
48	2D(H)	Vendor PN	-
49	54(H)	Vendor PN	T
50	49(H)	Vendor PN	I
51	2D(H)	Vendor PN	-
52	4E(H)	Vendor PN	N
53	20(H)	Vendor PN	
54	20(H)	Vendor PN	
55	20(H)	Vendor PN	
56	30(H)	Vendor rev	0
57	30(H)	Vendor rev	0
58	30(H)	Vendor rev	0
59	30(H)	Vendor rev	0
60	03(H)	Wavelength	850nm
61	52(H)	Wavelength	
62	00(H)	Unallocated	Unallocated
63		CC_BASE	
64	00(H)	Options	Unallocated
65	10(H)	Options	Tx_Disable;
66	00(H)	BR	max
67	00(H)	BR	min
68		Vendor SN	
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84		Date code	
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92	68(H)	Diagnostic Monitoring Type	Received Power Measurement Type;Internally Calibrated;Digital diagnostic monitoring implemented;
93	F0(H)	Enhanced Options	Alarm/warning Flags; TX_DISABLE control and monitoring; TX_FAULT monitoring; RX_LOS monitoring
94	03(H)	SFF-8472 Compliance	includes functionality described in Rev 10.2 of SFF-8472
95		CC_EXT	
96	45(H)	Vendor Specific	E
97	58(H)	Vendor Specific	X
98	54(H)	Vendor Specific	T
99	52(H)	Vendor Specific	R
100	45(H)	Vendor Specific	E
101	4D(H)	Vendor Specific	M
102	45(H)	Vendor Specific	E
103	4C(H)	Vendor Specific	L
104	59(H)	Vendor Specific	Y
105	20(H)	Vendor Specific	
106	43(H)	Vendor Specific	C
107	4F(H)	Vendor Specific	O
108	4D(H)	Vendor Specific	M

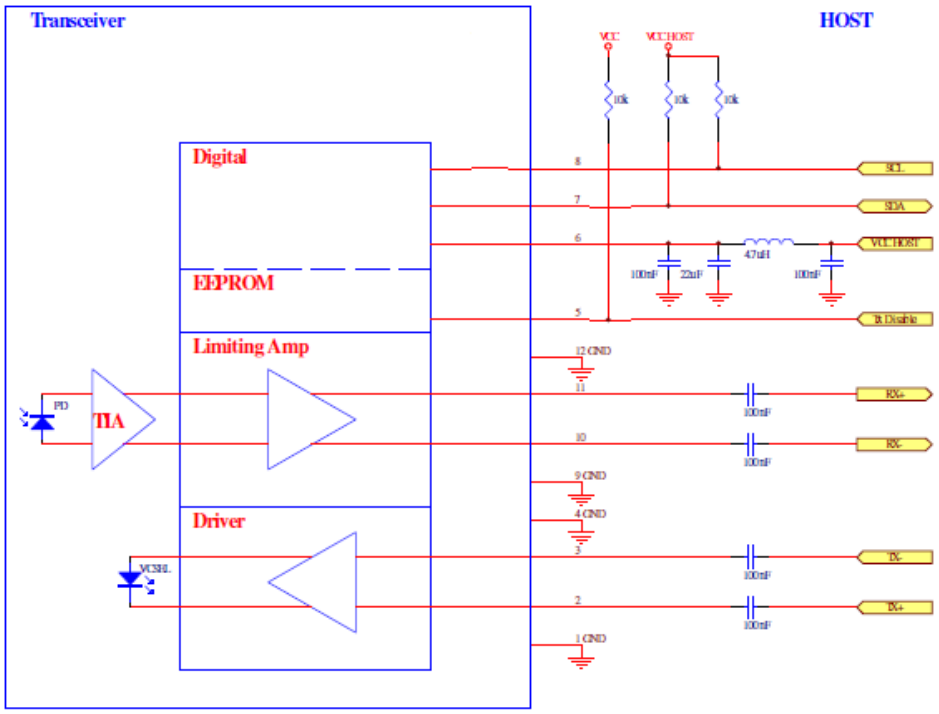
109	50(H)	Vendor Specific	P
110	41(H)	Vendor Specific	A
111	54(H)	Vendor Specific	T
112	49(H)	Vendor Specific	I
113	42(H)	Vendor Specific	B
114	4C(H)	Vendor Specific	L
115	45(H)	Vendor Specific	E
116	20(H)	Vendor Specific	
117	20(H)	Vendor Specific	
118	20(H)	Vendor Specific	
119	20(H)	Vendor Specific	
120	20(H)	Vendor Specific	
121	20(H)	Vendor Specific	
122	20(H)	Vendor Specific	
123	20(H)	Vendor Specific	
124	20(H)	Vendor Specific	
125	20(H)	Vendor Specific	
126	20(H)	Vendor Specific	
127	20(H)	Vendor Specific	

EEPROM Serial ID Memory Contents (A2h)

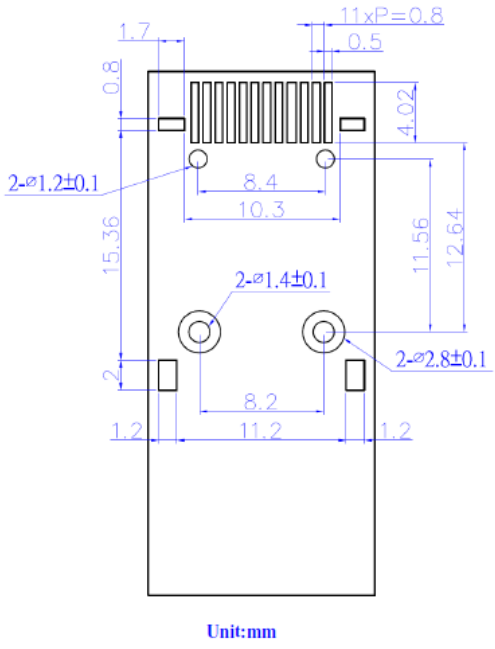
Address(A2h)	Description	Value
00-01	Temp High Alarm	90 Degree C
02-03	Temp Low Alarm	-45 Degree C
04-05	Temp High Warning	85 Degree C
06-07	Temp Low Warning	-40 Degree C
08-09	Voltage High Alarm	3.6 V
10-11	Voltage Low Alarm	3.0 V
12-13	Voltage High Warning	3.5 V
14-15	Voltage Low Warning	3.1 V
16-17	Bias High Alarm	10 mA
18-19	Bias Low Alarm	0.1 mA
20-21	Bias High Warning	9 mA
22-23	Bias Low Warning	0.5 mA
24-25	TX Power High Alarm	0 dBm
26-27	TX Power Low Alarm	-8.1 dBm
28-29	TX Power High Warning	-1 dBm
30-31	TX Power Low Warning	-7.1 dBm
32-33	RX Power High Alarm	0 dBm
34-35	RX Power Low Alarm	-14 dBm
36-37	RX Power High Warning	-1 dBm
38-39	RX Power Low Warning	-12 dBm
40-55	Reserved Reserved for future monitored quantities	
56-91	External calibration constant	

92-94	Reserved	
95	Check sum	
96-97	Real Time temperature	
98-99	Real Time supply voltage	
100-101	Real Time TX bias current	
102-103	Real Time TX optical power	
104-105	Real Time RX received power	
106-109	Reserved	
110(bit7)	NA	
110(bit6)	NA	
110(bit5)	Reserved	
110(bit4)	NA	
110(bit3)	NA	
110(bit2)	Digital state of TX fault output pin	
110(bit1)	Digital state of LOS output pin	
110(bit0)	NA	
111	Reserved	
112(bit7)	Set when internal temperature exceeds high alarm level	
112(bit6)	Set when internal temperature exceeds is below alarm level	
112(bit5)	Set when internal supply voltage exceeds high alarm level	
112(bit4)	Set when internal supply voltage is below alarm level	
112(bit3)	Set when TX bias exceeds high alarm level	
112(bit2)	Set when TX bias voltage is below alarm level	
112(bit1)	Set when TX output power exceeds high alarm level	
112(bit0)	Set when TX output power voltage is below alarm level	
113(bit7)	Set when RX received power exceeds high alarm level	
113(bit6)	Set when RX received power is below alarm level	
113(bit5-0)	Reserved	
114-115	Reserved	
116(bit7)	Set when internal temperature exceeds high warning level	
116(bit6)	Set when internal temperature exceeds is below warning level	
116(bit5)	Set when internal supply voltage exceeds high warning level	
116(bit4)	Set when internal supply voltage is below warning level	
116(bit3)	Set when TX bias exceeds high warning level	
116(bit2)	Set when TX bias voltage is below warning level	
116(bit1)	Set when TX output power exceeds high warning level	
116(bit0)	Set when TX output power voltage is below warning level	
117(bit7)	Set when RX received power exceeds high warning level	
117(bit6)	Set when RX received power is below warning level	
117(bit5-0)	Reserved	
118-119	Reserved	
120-127	Reserved	

Recommended Interface Circuit

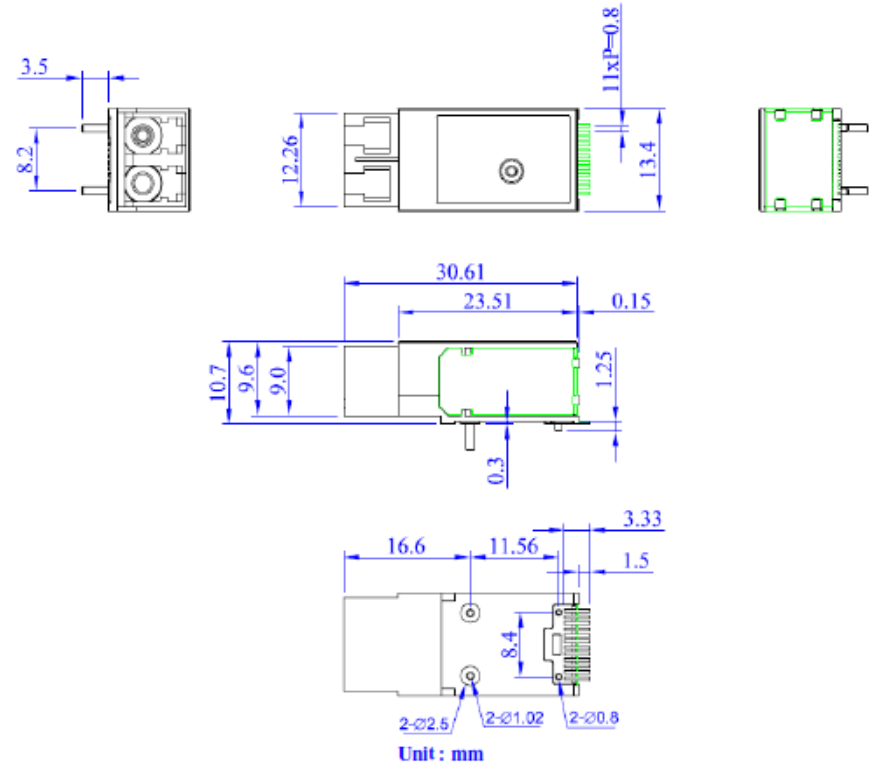


Recommended Host Board Mechanical Layout

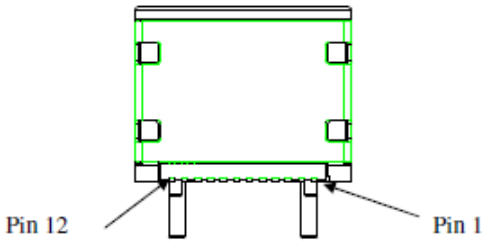


Unit:mm

Dimensions



Pin Assignment



PIN	SIGNAL NAME	DESCRIPTION
1	GND	Ground
2	TX+	Transmit Data in, ac coupled
3	TX-	Transmit Data in Bar, ac coupled
4	GND	Ground
5	TX_DISABLE	Transmit Disable
6	V_{CC}	3.3V Power Supply
7	MOD_DEF (2)	SDA Serial Data Signal
8	MOD_DEF (1)	SCL Serial Clock Signal
9	GND	Ground
10	RX-	Receive Data out Bar, ac coupled
11	RX+	Receive Data out, ac coupled
12	GND	Ground

Additional Notes

- Avoid eye or skin exposure to laser radiations.
- The device is sensitive to electro-static discharge (ESD). The device should be handled with ESD proof tools. To assemble the device on PCB, proper grounding is required to prevent ESD.
- Specifications are subject to change without notice.

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